



TOYO LED ELECTRONICS LIMITED

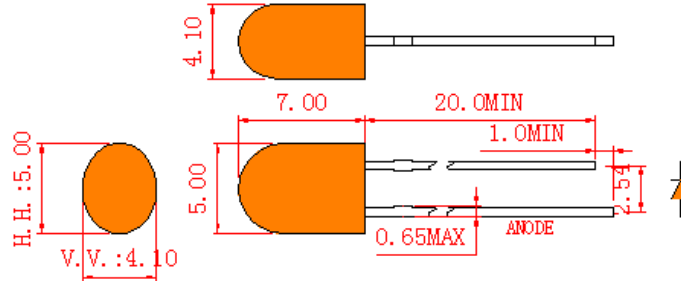
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 Http://www.toyo-led.com E-mail : sales@toyo-led.com



P/N: TY-571UA3D100-1500(20)

5*4 mm Round Type LEDs Series

PACKAGE DIMENSION



Selection Guide

Part No.	Dice		Lens Color	Iv(mcd)(If=20mA)			Viewing Angle (2θ½)
	Raw Material	Emitted Color		MIN	TYP	MAX	
TY-571UA3D100-1500(20)	AlGaInP	Amber	Amber Diffused	500	1500	---	H.H.: 100 °
				500	1500	---	V.V.: 50 °

Absolute Maximum Ratings(Ta=25C °)

Item	Symbol	Maximum	Unit
Power Dissipation	P _D	60	mW
Peak Forward Current (1/10 Duty Cycle 0.1ms Pulse Width)	I _{FP}	160	mA
Forward Current	I _{Fmax}	25	mA
Reverse Voltage	V _R	5	V
Operating / Storage Temperature Range	T _{opr} / T _{stg}	-40 °C to +85 °C	

Electrical / Optical Characteristics(Ta=25C °)

Item	Symbol	Min.	Typ.	Max.	Unit	Condition
Peak Wavelength	λ _p	-	610	-	nm	I _F =20mA
Dominant Wavelength	λ _d	600	605	610	nm	I _F =20mA
Forward Voltage	V _F	1.80	2.20	2.60	V	I _F =20mA
Capacitance	C	-	-	95	pF	V _F =0V;f=1MHz
Reverse Current	I _R	-	-	10	uA	V _R =5V

NOTES:

- All dimensions are in millimeter;
- Tolerance is ±0.25mm unless other specified; Luminous intensity testing tolerance is ±10%;
- Dominant Emission Wavelength testing tolerance is ±5%;
- Specifications are subject to change without notice



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■ Typical Electro-Optical Characteristic Curve:

FIG. 1 Forward Current Vs. Forward Voltage

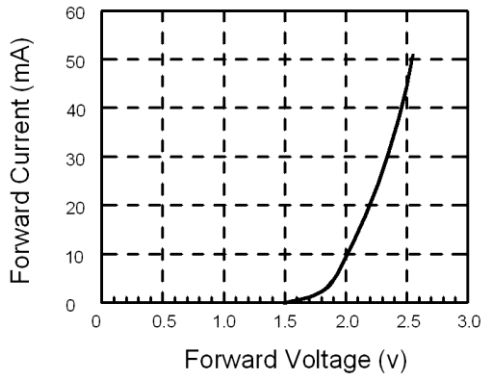


FIG. 2 Relative Luminosity Vs. Forward Current

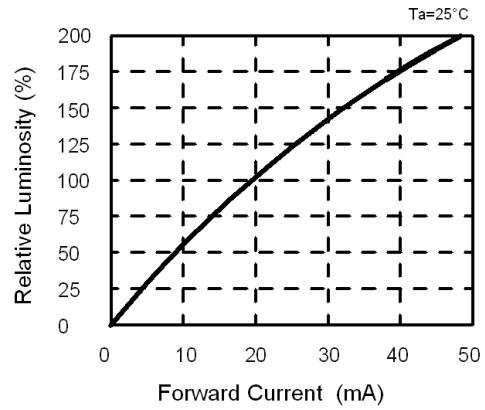


FIG. 3 Forward Current Vs. Temperature

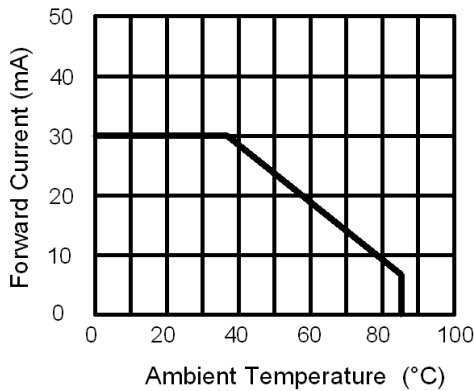


FIG. 4 Relative Luminosity Vs. Temperature

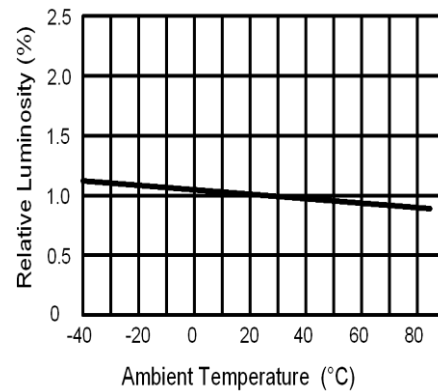
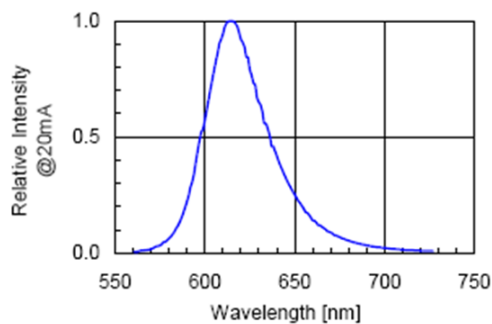


FIG. 5 Relative Intensity Vs. Wavelength





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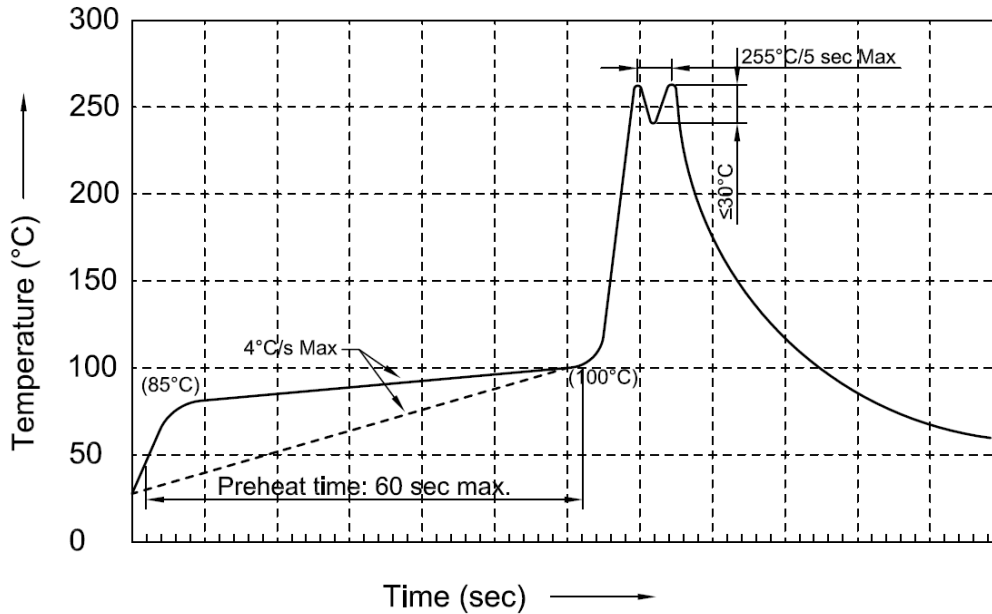
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Recommended Wave Soldering Profiles:



Notes:

1. Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C.
2. Peak wave soldering temperature between 245-255°C for 3 sec (5 sec max).
3. Do not apply stress to the epoxy resin while the temperature is above 85°C.
4. Fixtures should not incur stress on the component when mounting and soldering process.
5. More than one wave soldering is not allowed..



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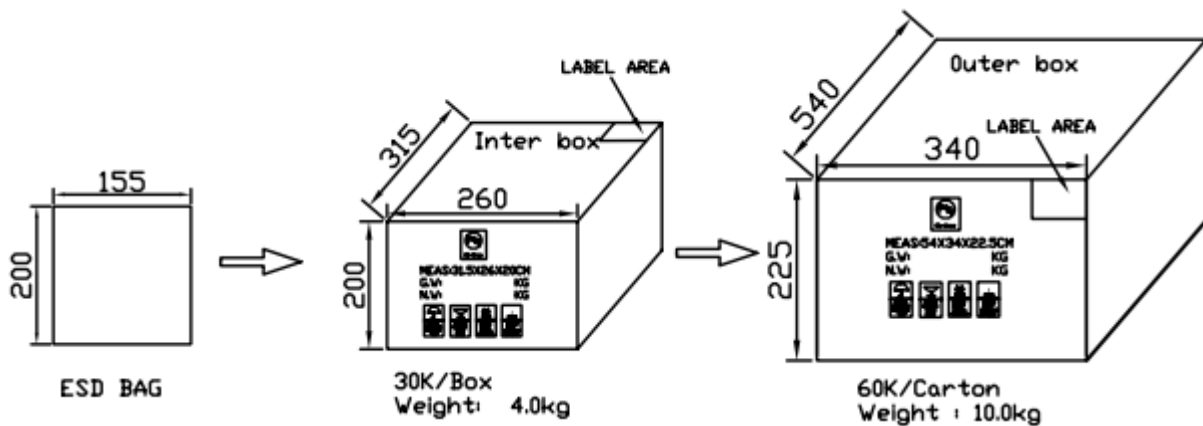
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BULK & PACKING DIMENSIONS



Notes:

1. All dimension are in millimeter;
2. Tolerance is ± 0.25 mm unless otherwise specified.
3. Not recommend to solder within 3mm from the resin.
4. Any kind of LEDs can be made in taped.

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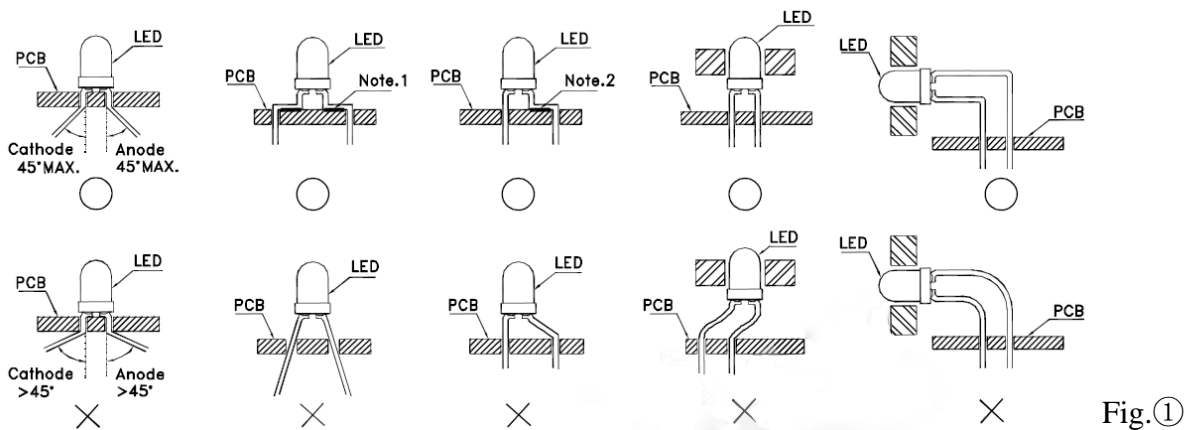
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OTHER NOTES

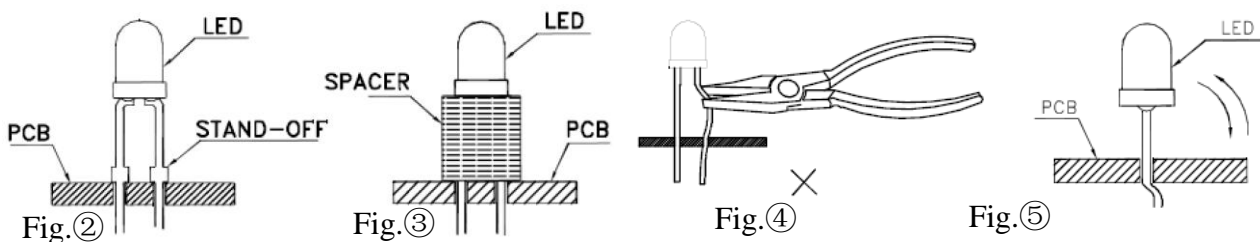
1. Storage conditions:

- a. Avoid continued exposure to the condensing moisture environment and keep the product away from rapid transitions in ambient temperature.
- b. LEDs should be stored with temperature $\leq 30^{\circ}\text{C}$ and relative humidity $\leq 60\%$.
- c. Product in the original sealed package is recommended to be assembled within 72 hours of opening. Product in opened package for more than a week should be baked for 30 (+10/-0) hours at 85-100°C.

2. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component. Lead-forming may be required to insure the lead pitch matches the pitch. Refer to the figure below for proper lead forming procedures. (Fig.①)



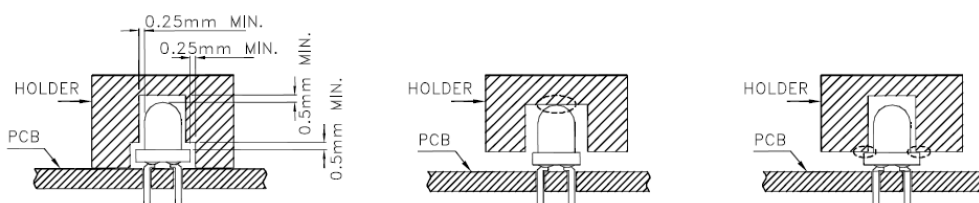
3. Use stand-offs (fig.②) or spacers (fig.③) to securely position the LED above the PCB.



4. During lead forming, use tools or jigs to hold the leads securely so that the bending force will not be transmitted to the LED lens and its internal structures. Do not perform lead forming once the component has been mounted onto the PCB.(fig.④)

5. Do not bend the leads more than twice. (fig.⑤)

6. During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during soldering.



7. The tip of the soldering iron should never touch the lens epoxy.

8. Through-hole LEDs are incompatible with reflow soldering.



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REVISION HISTORY

DATE	REVISION CONTENTS	VERSION
2015-05-15	New	A